

Data Sheet	January 2002

80A, 600V Ultrafast Diode

The RURG8060 is an ultrafast diode with soft recovery characteristics (t_{rr} < 75ns). It has low forward voltage drop and is of silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and ultrafast recovery with soft recovery characteristic minimize ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.

Formerly developmental type TA09886.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RURG8060	TO-247	RURG8060

NOTE: When ordering, use the entire part number.

Symbol



Features

•	Ultrafast with Soft Recovery
•	Operating Temperature175°C
•	Reverse Voltage

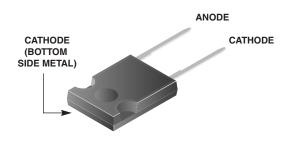
- Avalanche Energy Rated
- Planar Construction

Applications

- · Switching Power Supplies
- · Power Switching Circuits
- General Purpose

Packaging

JEDEC STYLE 2 LEAD TO-247



DUDCOOCO

Absolute Maximum Ratings $T_C = 25^{\circ}C$, Unless Otherwise Specified

	RURG8060	UNITS
Peak Repetitive Reverse Voltage	600	V
Working Peak Reverse VoltageV _{RWM}	600	V
DC Blocking Voltage V _R	600	V
Average Rectified Forward Current $I_{F(AV)}$ ($T_C = 72^{\circ}C$)	80	Α
Repetitive Peak Surge Current	160	Α
Nonrepetitive Peak Surge Current	800	Α
Maximum Power Dissipation	180	W
Avalanche Energy (See Figures 7 and 8)	50	mJ
Operating and Storage Temperature	-65 to 175	oC

LIMITO

Electrical Specifications $T_C = 25^{\circ}C$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
V _F	I _F = 80A	-	-	1.6	V
	I _F = 80A, T _C = 150°C	-	-	1.4	V
I _R	V _R = 600V	-	-	250	μΑ
	V _R = 600V, T _C = 150°C	-	-	2.0	mA
t _{rr}	$I_F = 1A$, $dI_F/dt = 100A/\mu s$	-	-	75	ns
	I _F = 80A, dI _F /dt = 100A/μs	-	-	85	ns
t _a	$I_F = 80A$, $dI_F/dt = 100A/\mu s$	-	40	-	ns
t _b	$I_F = 80A$, $dI_F/dt = 100A/\mu s$	-	25	-	ns
$R_{ heta JC}$		-	-	0.83	°C/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

I_R = Instantaneous reverse current.

 t_{rr} = Reverse recovery time (See Figure 6), summation of $t_a + t_b$.

 t_a = Time to reach peak reverse current (See Figure 6).

t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = pulse width.

D = duty cycle.

Typical Performance Curves

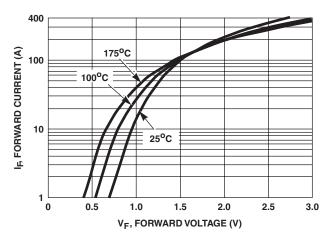


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

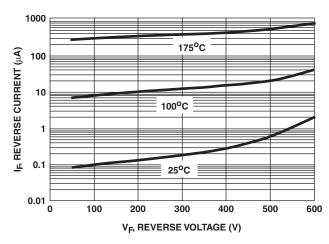


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

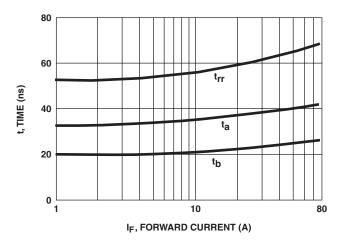


FIGURE 3. t_{rr} , t_a and t_b curves vs forward current

80 SQ. WAVE 20 25 50 75 100 125 150 175 TC, CASE TEMPERATURE (°C)

FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

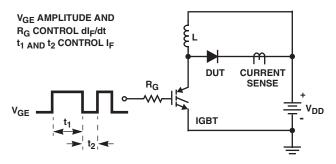


FIGURE 5. t_{rr} TEST CIRCUIT

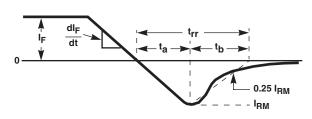


FIGURE 6. t_{rr} WAVEFORMS AND DEFINITIONS

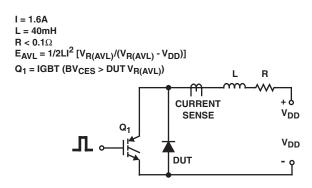


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

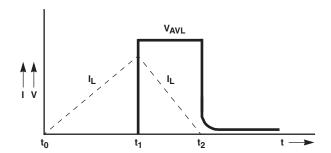


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

FAST ® SMART START™ VCX^{TM} ACEx™ OPTOLOGIC™ STAR*POWER™ FASTr™ Bottomless™ OPTOPLANAR™ Stealth™ CoolFET™ FRFET™ PACMANTM SuperSOT™-3 CROSSVOLT™ GlobalOptoisolator™ POP™ SuperSOT™-6 DenseTrench™ GTO™ Power247™ $\mathsf{HiSeC^{\mathsf{TM}}}$ SuperSOT™-8 DOME™ PowerTrench® SyncFET™ ISOPLANAR™ EcoSPARK™ QFET™ TinyLogic™ E²CMOSTM LittleFET™ OSTM EnSigna™ MicroFET™ TruTranslation™ QT Optoelectronics™ MicroPak™ UHC™ **FACT™** Quiet Series™ UltraFET® FACT Quiet Series™ MICROWIRE™ SILENT SWITCHER®

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS. NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Rev. H4